

NJD1718T4G

Power Transistors

PNP Silicon DPAK For Surface Mount Applications

Designed for high-gain audio amplifier and power switching applications.

Features

- Low Collector-Emitter Saturation Voltage –
 $V_{CE(sat)} = 0.5 \text{ Vdc (Max) @ } I_C = -1 \text{ A}$
- High Switching Speed: $t_{STG} = 320 \text{ ns (typ)}$
- Epoxy Meets UL 94 V-0 @ 0.125 in
- ESD Ratings: Human Body Model, 3B > 8000 V
Machine Model, C > 400 V
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Base Voltage	V_{CB}	-50	Vdc
Collector-Emitter Voltage	V_{CEO}	-50	Vdc
Emitter-Base Voltage	V_{EB}	-5	Vdc
Collector Current Continuous Peak	I_C	-2 -3	Adc
Base Current	I_B	-0.4	Adc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	15 0.1	W W/ $^\circ\text{C}$
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ * Derate above 25°C	P_D	1.68 0.011	W W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +150	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance Junction-to-Case Junction-to-Ambient*	$R_{\theta JC}$ $R_{\theta JA}$	10 89.3	$^\circ\text{C/W}$

*These ratings are applicable when surface mounted on the minimum pad sizes recommended.

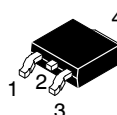


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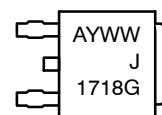
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**SILICON
POWER TRANSISTORS
2 AMPERES
50 VOLTS
15 WATTS**

MARKING DIAGRAM



DPAK
CASE 369C
STYLE 1



A = Assembly Location
Y = Year
WW = Work Week
G = Pb-Free Device

ORDERING INFORMATION

Device	Package	Shipping†
NJD1718T4G	DPAK (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage (Note 1) ($I_C = -10\text{ mAdc}$, $I_B = 0$)	BV_{CEO}	-50		-	Vdc
Collector Cutoff Current ($V_{CB} = -50\text{ Vdc}$, $I_E = 0$)	I_{CBO}	-		-100	nAdc
Emitter Cutoff Current ($V_{BE} = -5\text{ Vdc}$, $I_C = 0$)	I_{EBO}	-		-100	nAdc

ON CHARACTERISTICS

DC Current Gain (Note 1) ($I_C = -0.5\text{ A}$, $V_{CE} = 2\text{ V}$) ($I_C = -1.5\text{ Adc}$, $V_{CE} = 2\text{ Vdc}$)	h_{FE}	70 40		240 -	-
Collector-Emitter Saturation Voltage (Note 1) ($I_C = -1\text{ A}$, $I_B = -0.05\text{ A}$)	$V_{CE(sat)}$	-	-0.2	-0.5	Vdc
Base-Emitter Saturation Voltage (Note 1) ($I_C = -1\text{ A}$, $I_B = -0.05\text{ Adc}$)	$V_{BE(sat)}$	-	-	-1.2	Vdc
Base-Emitter On Voltage (Note 1) ($I_C = -1\text{ Adc}$, $V_{CE} = -2\text{ Vdc}$)	$V_{BE(on)}$	-	-	-1.2	Vdc

DYNAMIC CHARACTERISTICS

Current-Gain - Bandwidth Product (Note 2) ($I_C = -500\text{ mAdc}$, $V_{CE} = -2\text{ Vdc}$, $f_{test} = 10\text{ MHz}$)	f_T	-	80	-	MHz
Output Capacitance ($V_{CB} = 10\text{ Vdc}$, $I_E = 0$, $f = 0.1\text{ MHz}$)	C_{ob}	-	33	-	pF
Switching Timers $V_{CC} = -30\text{ V}$, $I_C = -1\text{ A}$ $I_B = -50\text{ mA}$, $R_B = 200\ \Omega$	t_{ON}	-	55	-	ns
	t_{STG}	-	320	-	
	t_f	-	40	-	

1. Pulse Test: Pulse Width = $300\ \mu\text{s}$, Duty Cycle $\approx 2\%$.
2. $f_T = |h_{fe}| \cdot f_{test}$.

TYPICAL CHARACTERISTICS

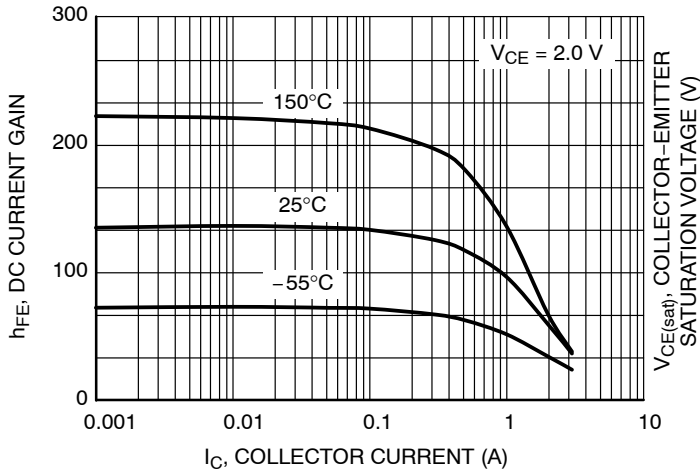


Figure 1. DC Current Gain

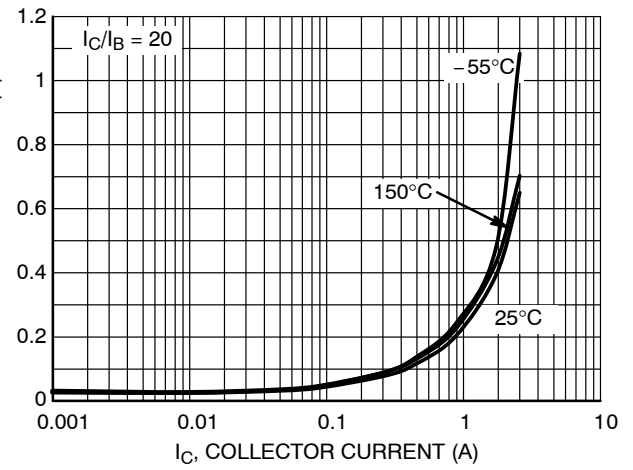


Figure 2. Collector-Emitter Saturation Voltage

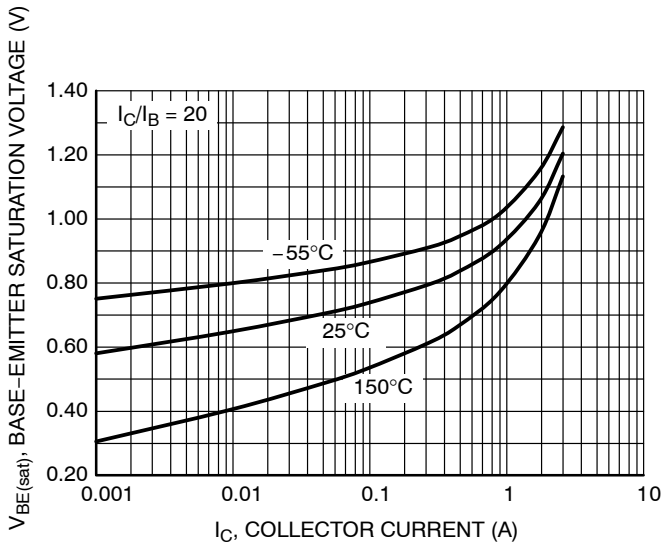


Figure 3. Base-Emitter Saturation Voltage

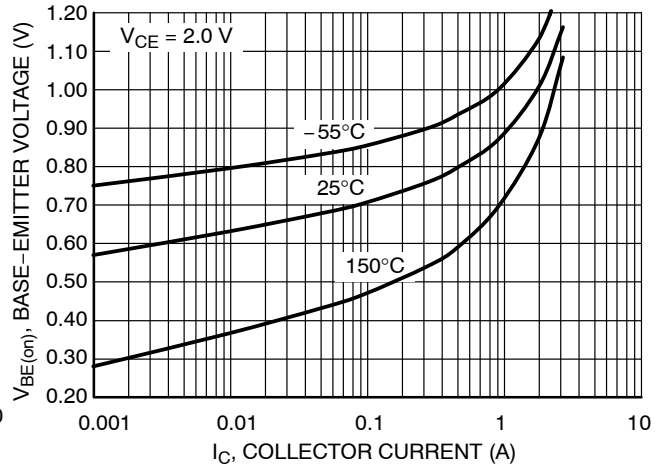


Figure 4. Base-Emitter Voltage

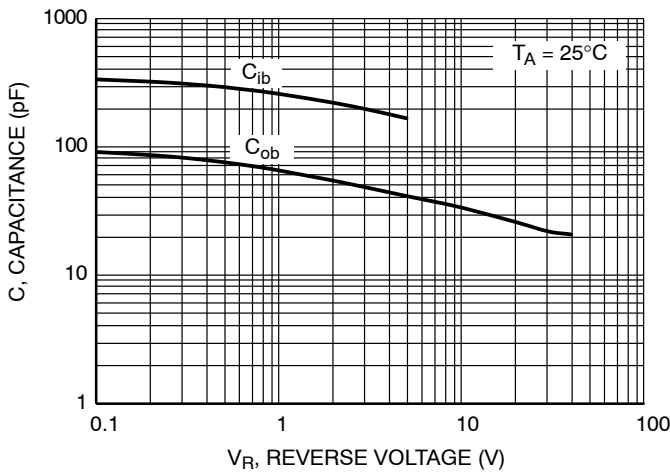


Figure 5. Capacitance

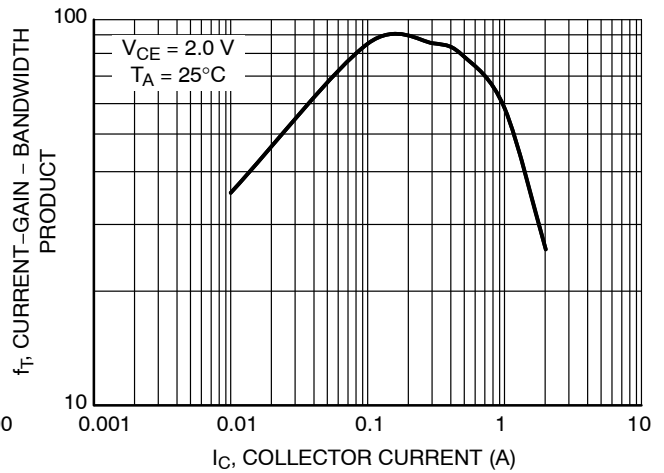
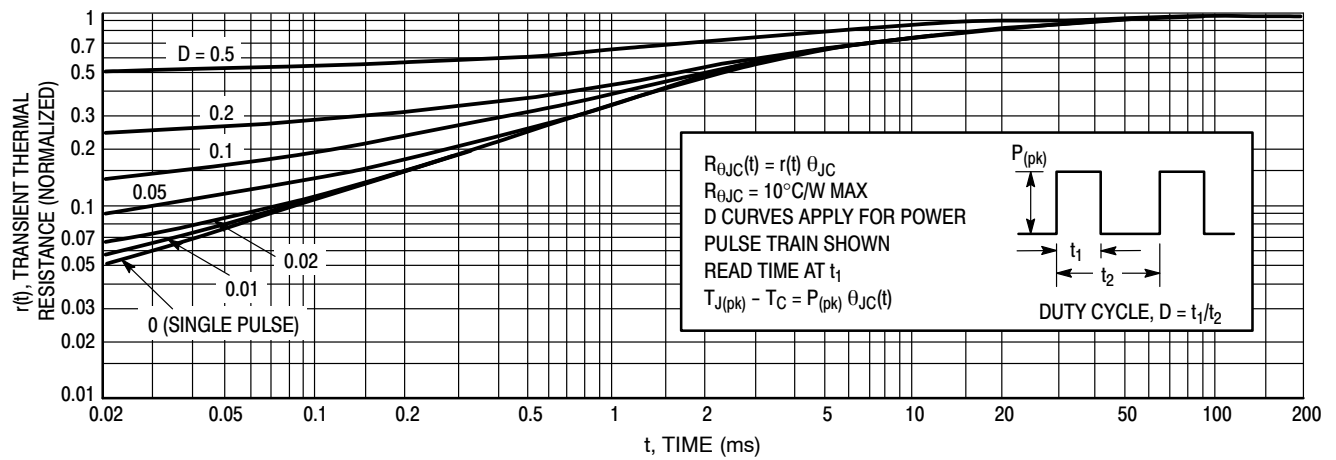
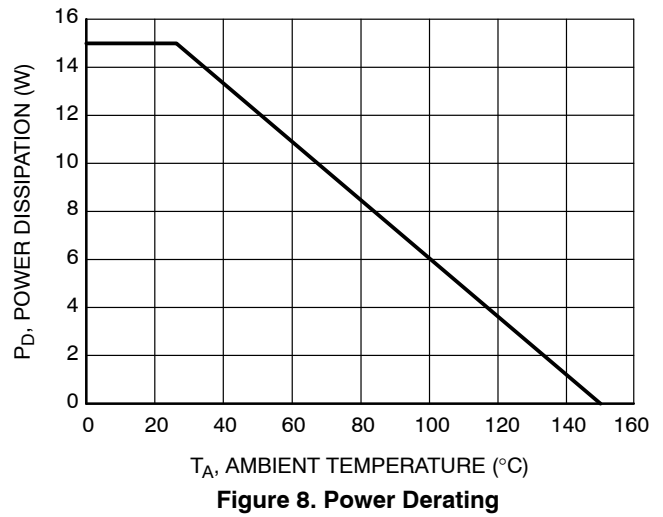
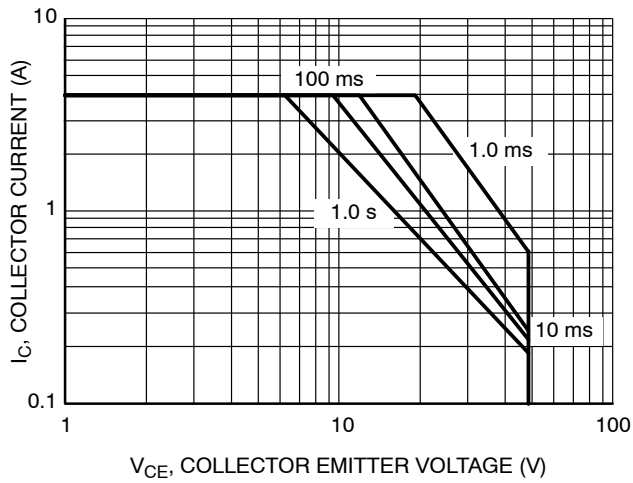


Figure 6. Current-Gain-Bandwidth Product

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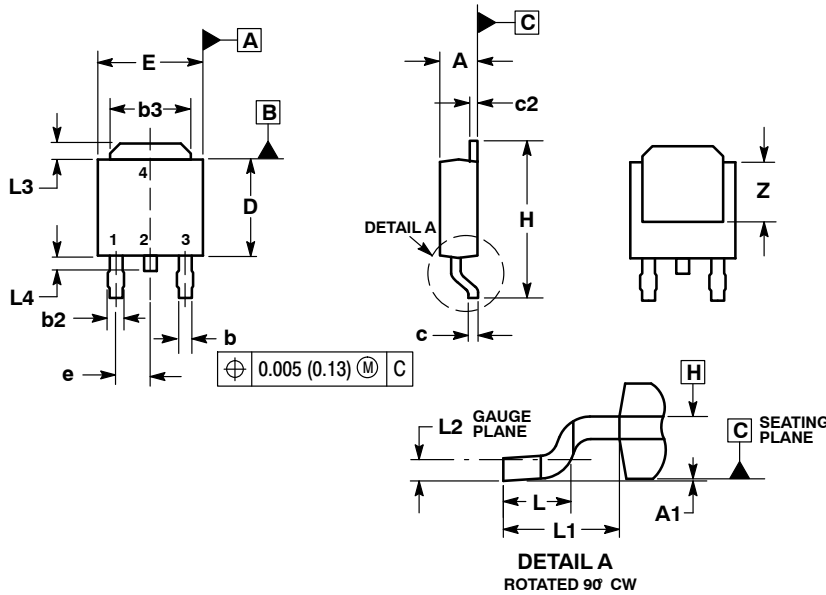
TYPICAL CHARACTERISTICS



NJD1718T4G

PACKAGE DIMENSIONS

DPAK CASE 369C-01 ISSUE D

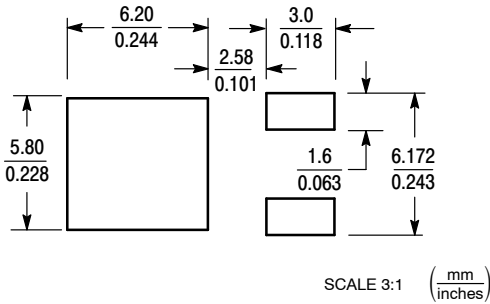


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES.
3. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS b3, L3 and Z.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
5. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
6. DATUMS A AND B ARE DETERMINED AT DATUM PLANE H.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.086	0.094	2.18	2.38
A1	0.000	0.005	0.00	0.13
b	0.025	0.035	0.63	0.89
b2	0.030	0.045	0.76	1.14
b3	0.180	0.215	4.57	5.46
c	0.018	0.024	0.46	0.61
c2	0.018	0.024	0.46	0.61
D	0.235	0.245	5.97	6.22
E	0.250	0.265	6.35	6.73
e	0.090 BSC		2.29 BSC	
H	0.370	0.410	9.40	10.41
L	0.055	0.070	1.40	1.78
L1	0.108 REF		2.74 REF	
L2	0.020 BSC		0.51 BSC	
L3	0.035	0.050	0.89	1.27
L4	---	0.040	---	1.01
Z	0.155	---	3.93	---

SOLDERING FOOTPRINT*



STYLE 1:

- PIN 1. BASE
- COLLECTOR
- EMITTER
- COLLECTOR

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

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Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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